



HEWBRQU2 Module Datasheet

Version: 20260228

Online Version

Contents

1. Overview	2
1.1. Features	2
1.2. Scope of applications	2
2. Module interfaces	4
2.1. Dimensions and footprint	4
3. Electrical parameters	5
3.1. Absolute electrical parameters	5
3.2. Operating conditions	5
3.3. Radio frequency (RF) power	6
3.4. Power consumption in operating mode	7
4. RF parameters	10
4.1. Basic RF features	10
4.2. Transmitter (TX) performance	10
5. Antenna information	13
5.1. Antenna type	13
5.2. Antenna interference reduction	13
6. Power-on and power-off sequence	14
6.1. Power-on sequence	14
6.2. Power-off sequence	14
7. Footprint and production instructions	16
7.1. Mechanical dimensions	16
7.2. Production instructions	18
7.3. Recommended oven temperature curve	20
7.4. Storage conditions	22
8. MOQ and packaging information	23
9. Appendix: Statement	24

The HEWBRQU2 module is a Wi-Fi and Bluetooth Low Energy (LE) combo module developed by Tuya Smart. This module consists of a highly integrated wireless RF chip W701-VA2-CG with built-in Wi-Fi stacks and various library functions.

1. Overview

HEWBRQU2 combines a low-power KM4 microcontroller unit (MCU), WLAN MAC, and 1T1R (1 transmitter/1 receiver) design. This module provides output frequency up to 100 MHz, 256 KB embedded SRAM, 2 MB flash memory, and configurable GPIOs that can function as digital peripherals for diverse applications.

HEWBRQU2 is a real-time operating system (RTOS), integrated with all Wi-Fi MAC and TCP/IP libraries. All these resources can help you develop your own embedded Wi-Fi products.

1.1. Features

- Built-in low-power KM4 MCU that also acts as an application processor.
- Clock rate of 100 MHz.
- Operating voltage range: 4.5V to 18V.
- Peripheral: 1 universal asynchronous receiver/transmitter (UART).
- Wi-Fi and Bluetooth connectivity
- IEEE 802.11b/g/n20.
- Channels 1-14@2.4 GHz (CH1-11 for US/CA and CH1-13 for EU/CN).
- Support security protocols, including WEP, WPA, WPA2, and WPA2 PSK (AES).
- Support Bluetooth LE 4.2.
- Support Wi-Fi Easy Connect (EZ mode) pairing mode on Android and iOS devices.
- Onboard PCB antenna.
- It has passed CE and FCC certifications.
- Operating temperature range: -20°C to $+85^{\circ}\text{C}$.

1.2. Scope of applications

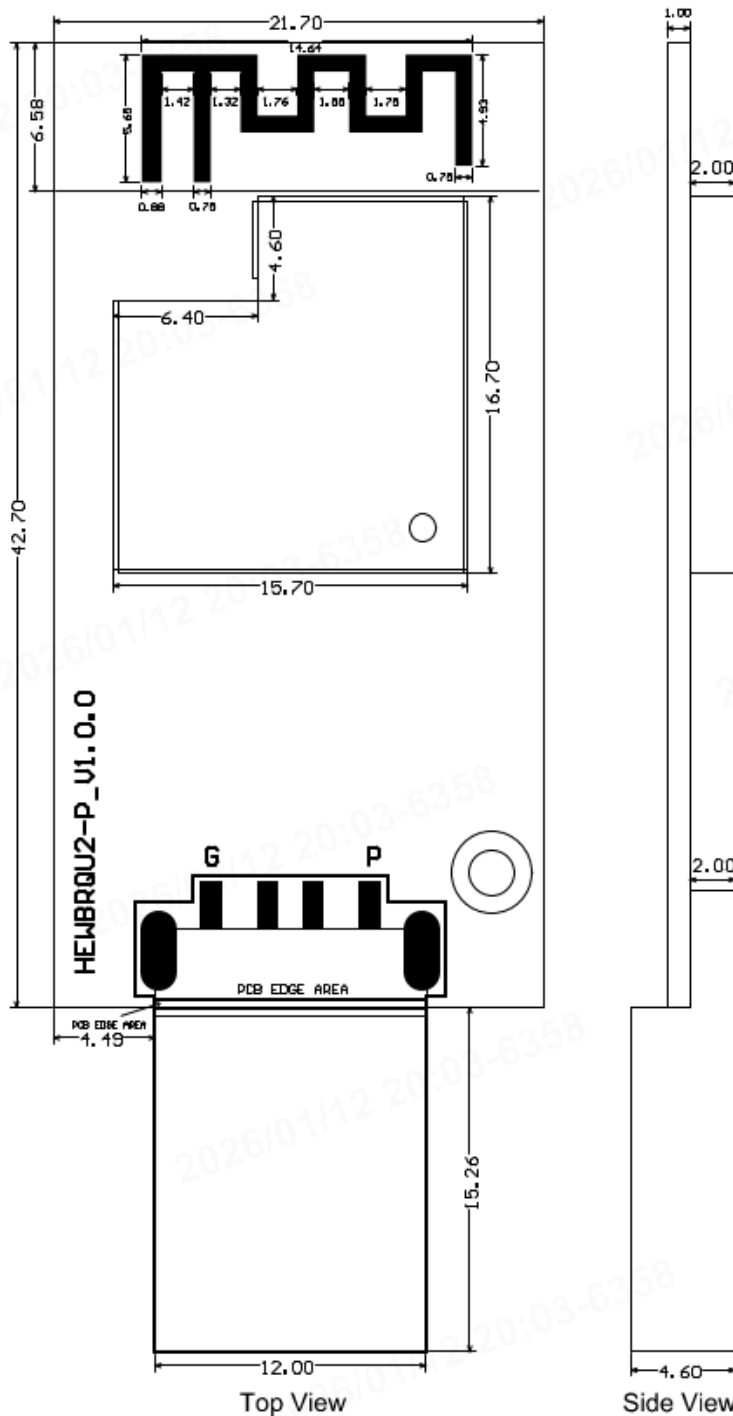
- Smart building
- Smart home
- Smart socket
- Smart lighting

- Smart bus
- Industrial wireless control
- Baby monitor
- IP camera

2. Module interfaces

2.1. Dimensions and footprint

The HEWBRQU2 dimensions are 57.96 ± 0.35 mm (W) $\times$ 21.70 ± 0.35 mm (L) $\times$ 4.6 ± 0.15 mm (H). The figure below shows the dimensions of the HEWBRQU2 module.



3. Electrical parameters

3.1. Absolute electrical parameters

Parameters	Description	Minimum value	Maximum value	Unit
T _s	Storage temperature	−40	105	°C
VDD	Supply voltage	−0.3	18	V
Electrostatic discharge voltage (human body model)	TAMB −25°C	-	2	kV
Electrostatic discharge voltage (machine model)	TAMB −25°C	-	0.5	kV

3.2. Operating conditions

Parameters	Description	Minimum value	Typical value	Maximum value	Unit
T _a	Operating temperature	−20	-	85	°C
VDD	Operating voltage	4.5	5	18	V
VIL	I/O low-level input	-	-	0.8	V
VIH	I/O high-level input	2.0	-	-	V

Parameters	Description	Minimum value	Typical value	Maximum value	Unit
VOL	I/O low-level output	-	-	0.4	V
VOH	I/O high-level output	2.4	-	-	V
I _{max}	I/O drive current	-	-	16	mA
C _{pad}	Input pin capacitor	-	2	-	pF

3.3. Radio frequency (RF) power

- Power consumption during continuous transmission (TX)

Symbol	Mode	Power	Average value	Peak (Typical) value	Unit
IRF	802.11b, 1 Mbit/s	17 dBm	171	246	mA
IRF	802.11b, 11 Mbit/s	17 dBm	162	240	mA
IRF	802.11g, 6 Mbit/s	17 dBm	156	230	mA
IRF	802.11g, 54 Mbit/s	15 dBm	130	226	mA
IRF	802.11n, BW20 MCS0	17 dBm	152	234	mA
IRF	802.11n, BW20 MCS7	14 dBm	124	218	mA

- Power consumption during continuous reception (RX)

Symbol	Mode	Average value	Peak (Typical) value	Unit
IRF	802.11b, 11 Mbit/s	55	71	mA
IRF	802.11g, 54 Mbit/s	50	70	mA
IRF	802.11n, HT20 MCS7	53	75	mA

3.4. Power consumption in operating mode

Operating mode	Status (Ta = 25°C)	Average value	Peak (Typical) value	Unit
Pairing over Bluetooth	The module is pairing over Bluetooth. The network status indicator blinks quickly.	49	280	mA
Pairing over AP	The module is in AP mode. The Wi-Fi network status indicator blinks slowly.	51	290	mA

Operating mode	Status (Ta = 25°C)	Average value	Peak (Typical) value	Unit
Connected and idle mode	The module is connected to the cloud. The network status indicator is steady on.	23	85	mA
Connected and operating mode	The module is connected to the cloud. The network status indicator is steady on.	45	276	mA
Weakly connected	The connection between the module and the access point is intermittent. The network status indicator is steady on.	49	265	mA

Operating mode	Status (Ta = 25°C)	Average value	Peak (Typical) value	Unit
Disconnected	The module is disconnected from the cloud. The network status indicator is steady off.	40	288	mA
Module disabled	The module's enable (EN) pin is pulled down.	13	49	mA

i

The above reference data is based on the module being powered by a DC regulated power supply at 5V, utilizing the Tuya-Haier firmware v1.0.3. For the same firmware, test results might vary slightly due to differences in the specific module, control board, and power supply used.

4. RF parameters

4.1. Basic RF features

Parameter	Description
Frequency range	2.400 to 2.4835 GHz
Wi-Fi standard	IEEE 802.11b/g/n (channels 1 to 14)
Bluetooth standard	Bluetooth LE 4.2
	• IEEE 802.11b: 1, 2, 5.5, and 11 Mbit/s
Data transmission rate	• IEEE 802.11g: 6, 9, 12, 18, 24, 36, 48, and 54 Mbit/s • IEEE 802.11n: HT20 MCS0-7
Antenna type	PCB antenna with a peak gain of 0.77 dBi

4.2. Transmitter (TX) performance

- Continuous TX performance:

Parameter	Minimum value	Typical value	Maximum value	Unit
RF average output power, 802.11b CCK mode, 1 Mbit/s	-	17	-	dBm
RF average output power, 802.11g OFDM mode, 54 Mbit/s	-	14	-	dBm

Parameter	Minimum value	Typical value	Maximum value	Unit
RF average output power, 802.11n OFDM mode, MCS7	-	13	-	dBm
RF average output power, Bluetooth LE 4.2, 1 Mbit/s	-	5	-	dBm
Frequency error	-20	-	20	ppm
EVM@802.11b CCK 11 Mbit/s mode, 17 dBm	-	-	-10	dB
EVM@802.11g OFDM 54 Mbit/s mode, 14 dBm	-	-	-29	dB
EVM@802.11n OFDM MCS7 mode, 13 dBm	-	-	-30	dB

• Receiver (RX) performance:

Parameter	Minimum value	Typical value	Maximum value	Unit
PER < 8%, RX sensitivity, 802.11b CCK mode, 1 Mbit/s	-	-96	-	dBm

Parameter	Minimum value	Typical value	Maximum value	Unit
PER < 10%, RX sensitivity, 802.11g OFDM mode, 54 Mbit/s	-	-75	-	dBm
PER < 10%, RX sensitivity, 802.11n OFDM mode, MCS7	-	-72	-	dBm
PER < 10%, RX sensitivity, Bluetooth LE 4.2, 1 Mbit/s	-	-93	-	dBm

5. Antenna information

5.1. Antenna type

This module has an onboard PCB antenna with a peak gain of 0.77 dBi.

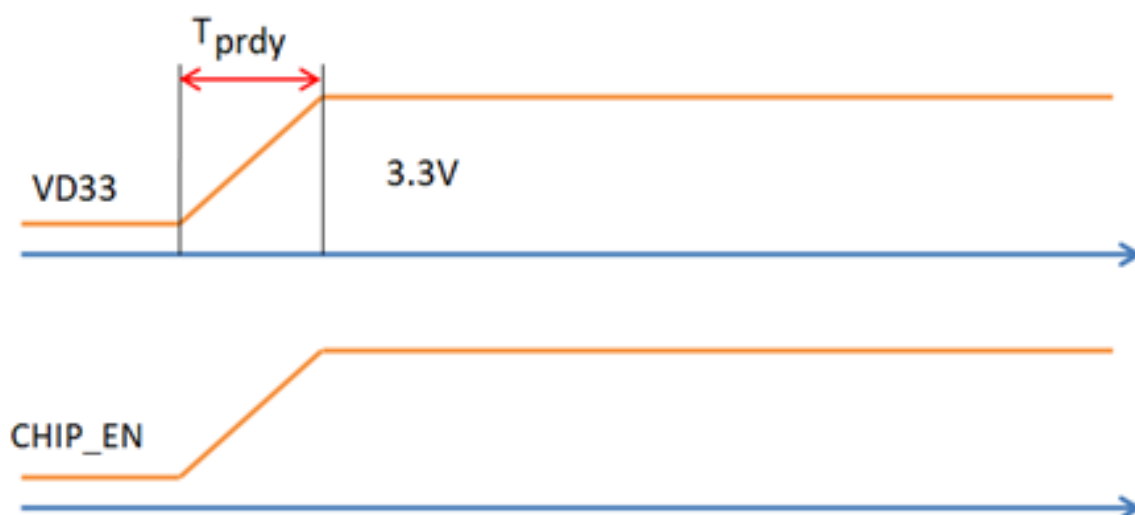
5.2. Antenna interference reduction

When a PCB antenna is used on a Wi-Fi module, we recommend that the module antenna is at least 15 mm away from other metal components. This can optimize the Wi-Fi performance.

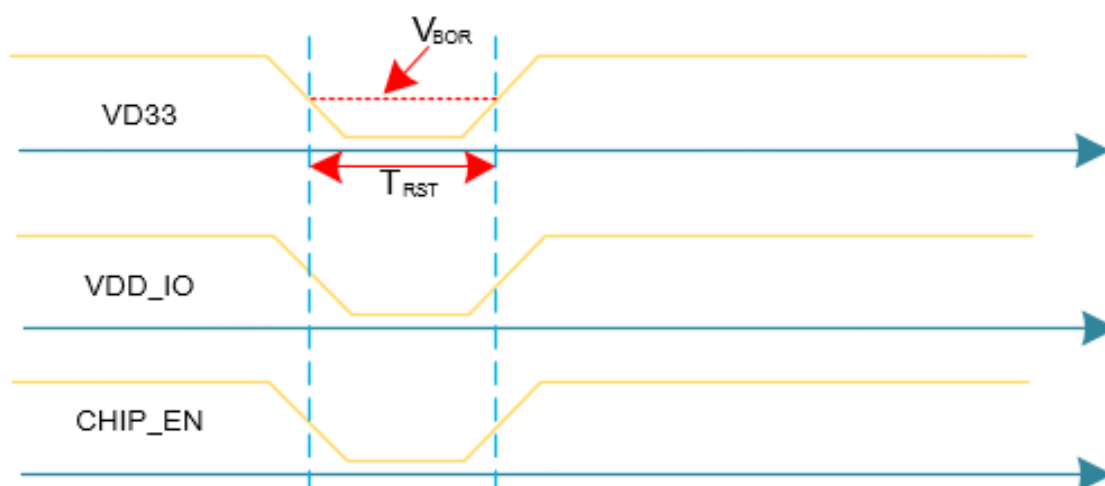
6. Power-on and power-off sequence

6.1. Power-on sequence

The W701 chip has requirements for the power-on sequence. It is recommended that the time for the voltage to rise from 0V to 3.3V should be within 20 ms.



6.2. Power-off sequence



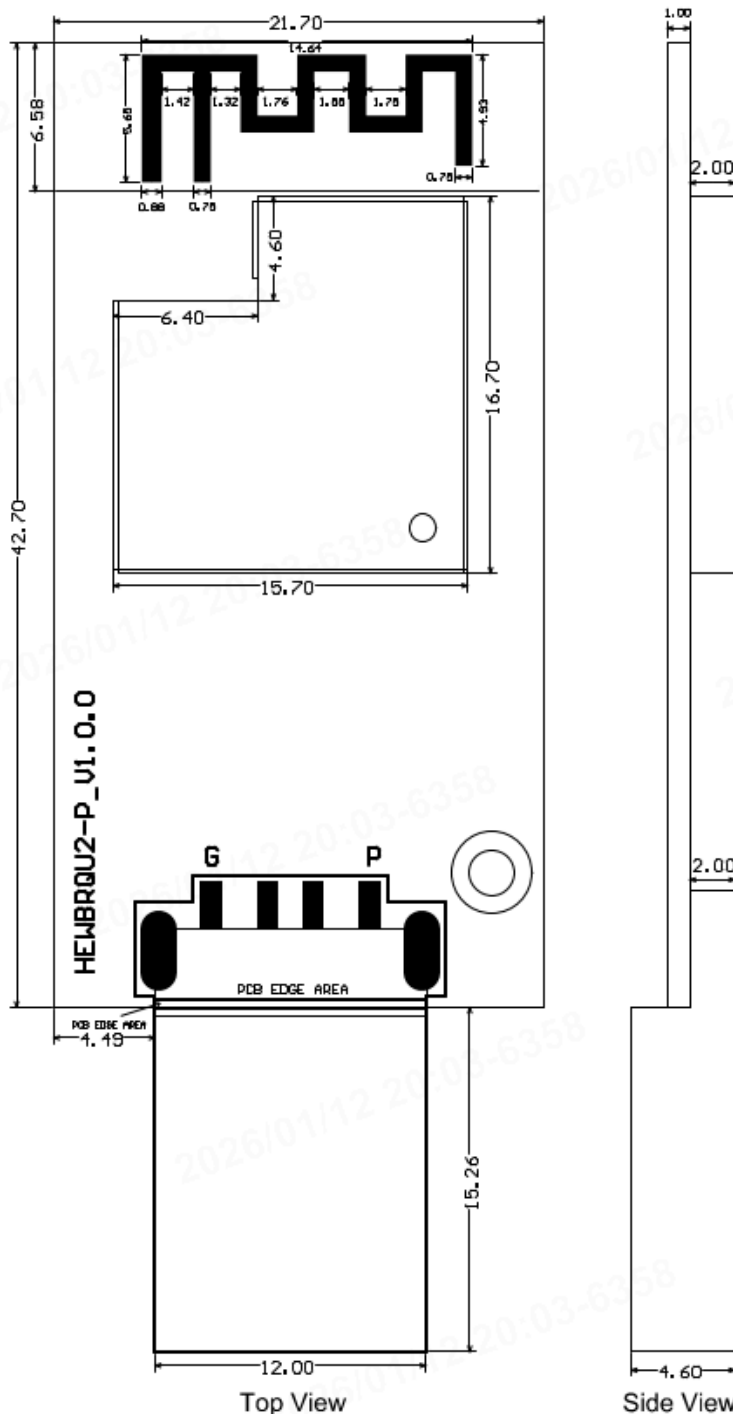
Symbol	Parameters	Minimum value	Typical value	Maximum value	Unit
TPRDY	3.3V ready time	0.6	-	20	ms

Symbol	Parameters	Minimum value	Typical value	Maximum value	Unit
CHIP_EN	CHIP_EN ready time	0.6	-	20	ms
VBOR	Brown-out reset (BOR) occurs after 3.3 V is lower than this voltage	2	-	-	V
TRST	The required time that 3.3 V is lower than VBOR	1	-	-	ms

7. Footprint and production instructions

7.1. Mechanical dimensions

The HEWBRQU2 module's PCB dimensions are 42.70 ± 0.35 mm (W) $\times$ 21.70 ± 0.35 mm (L) $\times$ 1.0 ± 0.15 mm (H). The figure below shows the dimensions of the HEWBRQU2 module.

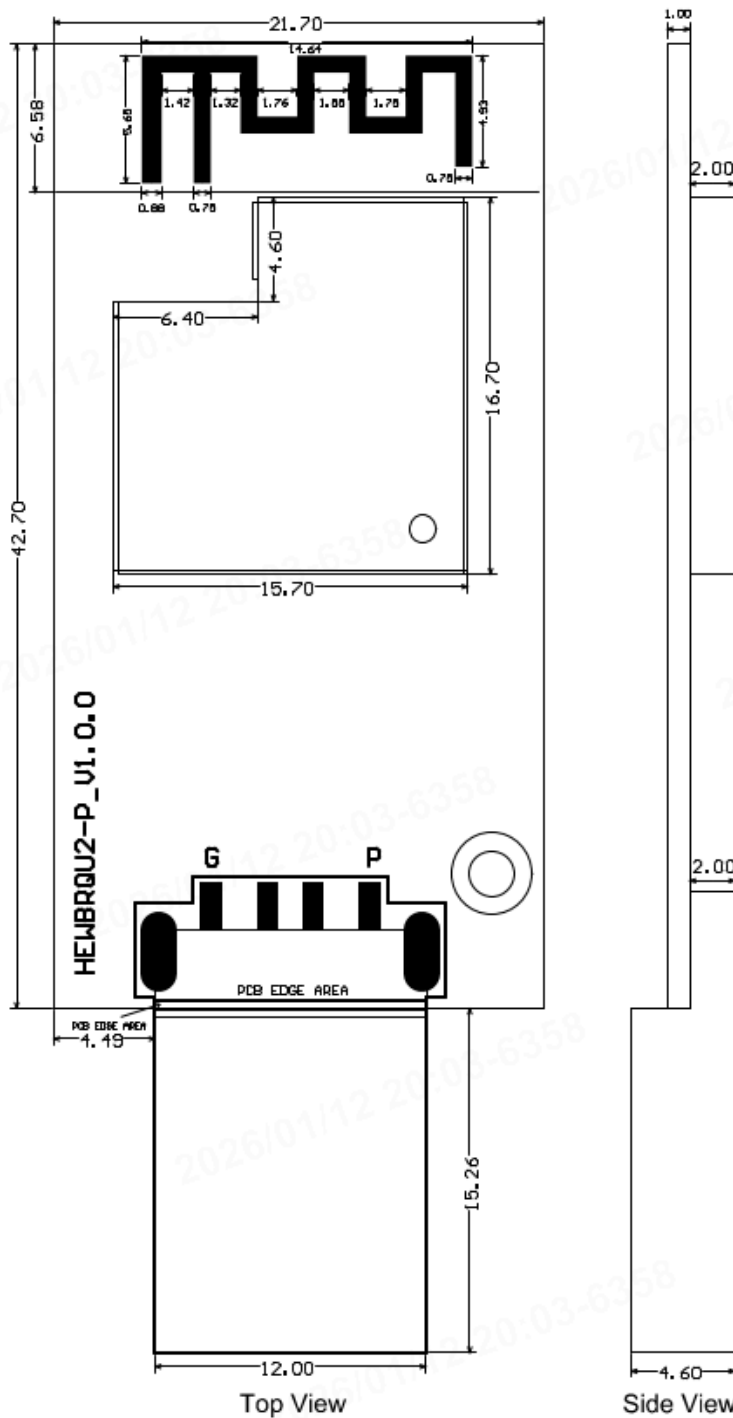


Unit: mm

Module form factor tolerance: $\pm 0.35\text{mm}$

PCB thickness tolerance: $\pm 0.1\text{mm}$

Shield cover height tolerance: $\pm 0.05\text{mm}$



Unit: mm

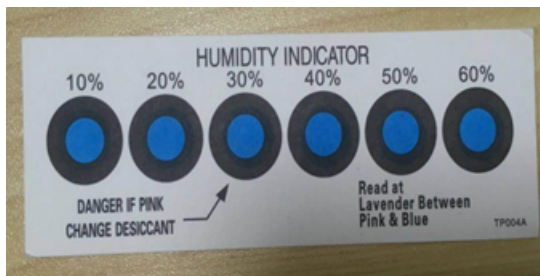
Module form factor tolerance: $\pm 0.35\text{mm}$

PCB thickness tolerance: $\pm 0.1\text{mm}$

Shield cover height tolerance: $\pm 0.05\text{mm}$

packing time and duration of exposure. The total exposure time cannot exceed 168 hours.

- Instruments or devices required for the SMT process:
- Surface mount system
- SPI
- Reflow soldering machine
- Thermal profiler
- Automated optical inspection (AOI) equipment
- Instruments or devices required for the baking process:
- Cabinet oven
- Electrostatic discharge (ESD) protection and heat-resistant trays
- ESD protection and heat-resistant gloves
- A delivered module must meet the following storage requirements:
- The moisture-proof bag must be placed in an environment where the temperature is below 40°C and the relative humidity is lower than 90%.
- The shelf life of a dry-packaged product is 12 months from the date when the product is packaged and sealed.
- A humidity indication card (HIC) is put in the sealed package.

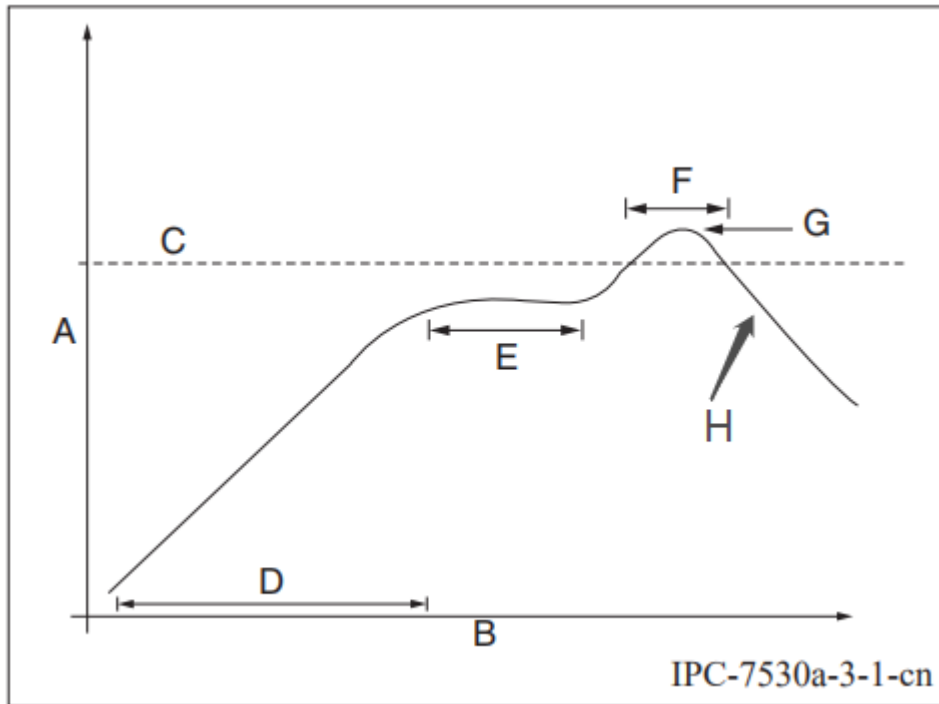


- The module needs to be baked in the following cases:
- The vacuum packaging bag is damaged before unpacking.
- After unpacking, no HIC is found in the packaging bag.
- After unpacking, the HIC indicates a humidity level of 10% or higher. In this case, the circle turns pink on the HIC.
- The total exposure time has lasted for over 168 hours since unpacking.
- More than 12 months have passed since the first sealing of the bag.
- The baking parameter settings are described below:

- Baking temperature: 40°C for reel packaging with relative humidity $\leq$ 5%. And 125°C for tray packaging with relative humidity $\leq$ 5% (use a heat-resistant tray, rather than a plastic container).
- Baking time: 168 hours for reel packaging and 12 hours for tray packaging.
- Temperature for triggering an alert: 50°C for reel packaging and 135°C for tray packaging.
- Production can begin after a module has cooled down to below 36°C under natural conditions.
- If a module remains unused for over 168 hours after being baked, it needs to be baked again.
- If a batch of modules is not baked after exposure for more than 168 hours, do not use wave soldering to solder them. Because these modules are level-3 moisture-sensitive devices, they are very likely to get damp when exposed beyond the allowable time. In this case, if they are soldered at high temperatures, device failure or poor soldering performance might occur.
- In the whole production process, take electrostatic discharge (ESD) protective measures.
- To guarantee the pass rate, we recommend that you use the SPI and AOI to monitor the quality of solder paste printing and mounting.

7.3. Recommended oven temperature curve

Set the temperature according to the following temperature curve of reflow soldering. The peak temperature is 245°C.



- A: temperature axis
- B: time axis
- C: alloy liquidus temperature from 217°C to 220°C
- D: ramp-up slope from 1°C/s to 3°C/s
- E: keep a constant temperature from 150°C to 200°C for a time period from 60s to 120s
- F: keep a temperature above liquidus temperature for 50s to 70s
- G: peak temperature from 235°C to 245°C
- H: ramp-down slope from 1°C/s to 4°C/s



The curve above is based on solder paste SAC305. For more information about other solder pastes, see the recommended oven temperature curve in the specified solder paste specifications.

7.4. Storage conditions

	Caution This bag contains MOISTURE-SENSITIVE DEVICES	LEVEL 3 If blank, see adjacent bar code label
1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH)		
2. Peak package body temperature: <u>260</u> °C If blank, see adjacent bar code label		
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be		
a) Mounted within: <u>168</u> hours of factory conditions If blank, see adjacent bar code label ≤30°C/60% RH, or		
b) Stored per J-STD-033		
4. Devices require bake, before mounting, if:		
a) Humidity Indicator Card reads >10% for level 2a - 5a devices or >60% for level 2 devices when read at 23 ± 5°C		
b) 3a or 3b are not met		
5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure		
Bag Seal Date: <u>See Production Date</u> If blank, see adjacent bar code label		
Note: Level and body temperature defined by IPC/JEDEC J-STD-020		

8. MOQ and packaging information

Model	MOQ (pcs)	Shipping packaging	Modules per reel	Reels per carton
HEWBRQU2	3,600	Tape and reel	900	4

9. Appendix: Statement

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this device. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

List of applicable FCC rules This module has been granted modular approval as below listed FCC rule parts. FCC Rule parts 15C (15.247)

List of applicable ISED rules This module has been certificated modular approval as below listed ISED Radio Standards Specifications. RSS 247 Issue 4 This device generates, uses, and can radiate radio frequency energy and, if not installed and used following the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this device does cause harmful interference to radio or television reception, which can be determined by turning the device off and on, the user is encouraged to try to correct the interference by one or more of the following measures: • Reorient or relocate the receiving antenna. • Increase the separation between the device and receiver. • Connect the device to an outlet on a circuit different from that to which the receiver is connected. • Consult the dealer or an experienced radio/TV technician for help.

Radiation Exposure Statement

This device complies with FCC radiation exposure limits set forth for an uncontrolled rolled environment. This device should be installed and operated with a minimum distance of 20cm between the radiator and your body.

Important Note

This radio module must not be installed to co-locate and operate simultaneously with other radios in the host system except following FCC multi-transmitter product procedures. Additional testing and device authorization may be required to operate simultaneously with other radios.

The availability of some specific channels and/or operational frequency bands is country dependent and is firmware programmed at the factory to match the intended destination. The firmware setting is not accessible to the end-user.

The host product manufacturer is responsible for compliance with any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. The final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed.

The end-user manual shall include all required regulatory information/warnings as shown in this manual, including “This product must be installed and operated with a minimum distance of 20 cm between the radiator and user body”.

This device has got an FCC ID: 2ANDL-HEWBRQU2. The end product must be labeled in a visible area with the following: “Contains Transmitter Module FCC ID: 2ANDL-HEWBRQU2”.

This device is intended only for OEM integrators under the following conditions:

The antenna must be installed such that 20cm is maintained between the antenna and users, and the transmitter module may not be co-located with any other transmitter or antenna.

As long as the 2 conditions above are met, further transmitter tests will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed.

This radio transmitter [23243-HEWBRQU2] has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Cet émetteur radio [23243-HEWBRQU2] a été approuvé par Innovation, Sciences et Développement économique Canada pour fonctionner avec les types d’antennes énumérés ci-dessous, avec le gain maximal autorisé indiqué. Les types d’antennes non inclus dans cette liste et dont le gain est supérieur au gain maximal indiqué pour tout type listé sont strictement interdits pour utilisation avec cet appareil.

Declaration of Conformity European Notice



Hereby, Hangzhou Tuya Information Technology Co., Ltd declares that this module product is in compliance with essential requirements and other relevant provisions of Directive 2014/53/EU, 2011/65/EU. A copy of the Declaration of conformity can be found at <https://www.tuya.com>.



This product must not be disposed of as normal household waste, in accordance with the EU directive for waste electrical and electronic equipment (WEEE-2012/19/EU). Instead, it should be disposed of by returning it to the point of sale, or to a municipal recycling collection point.

The device could be used with a separation distance of 20cm from the human body.

Industry Canada Statement This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions: (1) This device may not cause interference. (2) This device must accept any interference, including interference that may cause undesired operation of the device. Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage. (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Radiation Exposure Statement This equipment complies with IC radiation exposure limits set forth for an uncontrolled environment. This equipment should

be installed and operated with a minimum distance of 20 cm between the radiator & your body.

Déclaration d'exposition aux radiations: Cet équipement est conforme aux limites d'exposition aux rayonnements ISED établies pour un environnement non contrôlé. Cet équipement doit être installé et utilisé avec un minimum de 20 cm de distance entre la source de rayonnement et votre corps. L'appareil peut interrompre automatiquement la transmission en cas d'absence d'informations à transmettre ou de panne opérationnelle. Notez que ceci n'est pas destiné à interdire la transmission d'informations de contrôle ou de signalisation ou l'utilisation de codes répétitifs lorsque cela est requis par la technologie.

This device is intended only for OEM integrators under the following conditions: (1) The antenna must be installed such that 20 cm is maintained between the antenna and users. (2) The transmitter module may not be co-located with any other transmitter or antenna. As long as 2 conditions above are met, further transmitter tests will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed.

Cet appareil est conçu uniquement pour les intégrateurs OEM dans les conditions suivantes: (Pour utilisation de dispositif module) (1) L'antenne doit être installée de telle sorte qu'une distance de 20 cm est respectée entre l'antenne et les utilisateurs. (2) Le module émetteur peut ne pas être coïmplanté avec un autre émetteur ou antenne.

Tant que les 2 conditions ci-dessus sont remplies, des essais supplémentaires sur l'émetteur ne seront pas nécessaires. Toutefois, l'intégrateur OEM est toujours responsable des essais sur son produit final pour toutes exigences de conformité supplémentaires requis pour ce module installé.

IMPORTANT NOTE: In the event that these conditions can not be met (for example, certain laptop configurations or colocation with another transmitter), then the Canada authorization is no longer considered valid and the IC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate Canada authorization.

NOTE IMPORTANTE: Dans le cas où ces conditions ne peuvent être satisfaites (par exemple pour certaines configurations d'ordinateur portable ou de certaines co-localisation avec un autre émetteur), l'autorisation du Canada n'est plus considéré comme valide et l'ID IC ne peut pas être utilisé sur le produit final. Dans ces circonstances, l'intégrateur OEM sera chargé de réévaluer le produit final (y compris l'émetteur) et l'obtention d'une autorisation distincte au Canada.

End Product Labeling This transmitter module is authorized only for use in a device where the antenna may be installed such that 20 cm may be maintained between the antenna and users. The final end product must be labeled in a visible area with the following: "Contains IC:23243-HEWBRQU2".

Plaque signalétique du produit final Ce module émetteur est autorisé uniquement pour une utilisation dans un dispositif où l'antenne peut être installée de telle sorte qu'une distance de 20cm peut être maintenue entre l'antenne et les utilisateurs. Le produit final doit être étiqueté dans un endroit visible avec l'inscription suivante: "Contient des IC:23243-HEWBRQU2".

Manual Information To the End User The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product that integrates this module. The end user manual shall include all required regulatory information/warning as shown in this manual.

Manuel d'information à l'utilisateur final L'intégrateur OEM doit être conscient de ne pas fournir des informations à l'utilisateur final quant à la façon d'installer ou de supprimer ce module RF dans le manuel de l'utilisateur du produit final qui intègre ce module. Le manuel de l'utilisateur final doit inclure toutes les informations réglementaires requises et avertissements comme indiqué dans ce manuel.